

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Dong Wook Kim</td> <td>04/11/2013</td> </tr> <tr> <td>Victor Adrian Chiriac</td> <td>04/11/2013</td> </tr> <tr> <td>Kyu-Pyung Hwang</td> <td>04/11/2013</td> </tr> <tr> <td>Changhan Hobie Yun</td> <td>04/12/2013</td> </tr> <tr> <td>Young Kyu Song</td> <td>04/11/2013</td> </tr> </tbody> </table>		Name	Execution Date	Dong Wook Kim	04/11/2013	Victor Adrian Chiriac	04/11/2013	Kyu-Pyung Hwang	04/11/2013	Changhan Hobie Yun	04/12/2013	Young Kyu Song	04/11/2013
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<table border="1"> <tr> <td>Name:</td> <td>QUALCOMM Incorporated</td> </tr> <tr> <td>Street Address:</td> <td>5775 Morehouse Drive</td> </tr> <tr> <td>City:</td> <td>San Diego</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>92121</td> </tr> </table>		Name:	QUALCOMM Incorporated	Street Address:	5775 Morehouse Drive	City:	San Diego	State/Country:	CALIFORNIA	Postal Code:	92121		
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CORRESPONDENCE DATA													
<p>Fax Number: 8586582502  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Email: us-docketing@qualcomm.com</p> <p>Correspondent Name: QUALCOMM Incorporated</p> <p>Address Line 1: 5775 Morehouse Drive</p> <p>Address Line 4: San Diego, CALIFORNIA 92121</p>													
ATTORNEY DOCKET NUMBER:	124211												
NAME OF SUBMITTER:	Lisa Nodarse												
Signature:	/Lisa Nodarse/												

Date:

04/18/2013

**Total Attachments: 3**

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ASSIGNMENT

WHEREAS, WE,

1. **Dong Wook Kim**, a citizen of **Korea**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121** and a resident of **San Diego, CA**,
2. **Victor Adrian Chiriac**, a citizen of **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121** and a resident of **San Diego, CA**,
3. **Kyu-Pyung Hwang**, a citizen of **Korea**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121** and a resident of **San Diego, CA**,
4. **Changhan Hobie Yun**, a citizen of **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121** and a resident of **San Diego, CA**,
5. **Young Kyu Song**, a citizen of **Korea**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121** and a resident of **San Diego, CA**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **THERMAL DESIGN AND ELECTRICAL ROUTING FOR MULTIPLE STACKED PACKAGES USING THROUGH VIA INSERT (TVI)** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at **5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.**, desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/787,476** filed **March 6, 2013**, Qualcomm Reference No. **124211**, and all provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all

reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

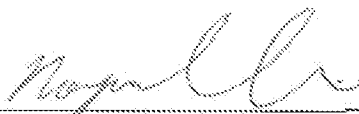
AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

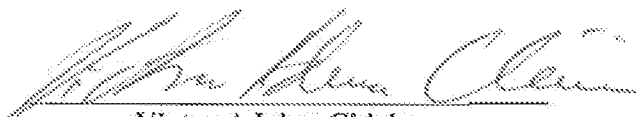
AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

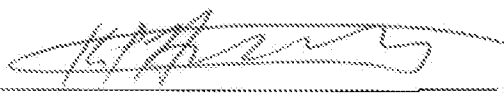
AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

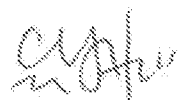
AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

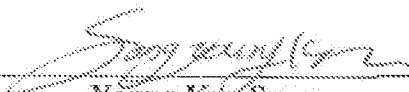
AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 4/11/13  
LOCATION DATE  
  
Dong Wook Kim

Done at San Diego, on 4/11/2013  
LOCATION DATE  
  
Victor Adrian Chiriac

Done at SAN DIEGO, on 4/11/13  
LOCATION DATE  
  
Kyu-Pyung Hwang

Done at San Diego CA, on 4/12/13  
LOCATION DATE  
  
Changan Hobbie Yun

Done at San Diego, on 4/11/13  
LOCATION DATE  
  
Young Kyu Song